□ MN152811

Туре			MN152811				
ROM (×8	I-Bit)		8 K				
RAM (×4-Bit)			256				
Number of Instructions			115				
Minimum Instruction Execution Time			2.0 μs (at 4.5 V to 5.5 V, 6 MHz)				
Interrupt	S		RESET • SIRQ • Remote Control Input • Timer • Serial (Only when choosing Mask Option)				
Timer Counter			Timer Counter : 8-Bit × 1 (Timer Output, Event Count) Clock Source 1/2, 1/8, 1/32, 1/128 of System Clock Interrupt Source Overflow of Timer Counter				
Serial In	terface		Serial : 8-Bit × 1 Clock Source . System Clock, SBT Pin Input				
I/O Pins	1/0	5	Common use 2 • Specified pull-up Resistor available (Mask Option) 2 Nch Open-Drain available (Output) 5				
	Input	4	Common use 1 • Specified pull-up Resistor available (Mask Option) 1 Output selectable (Software Programmable) 3				
	High Voltage Output	5	Nch Open-Drain (Breakdown Voltage 12 V) 5 Push-Pull Output selectable (Mask Option) 4				
	Output	3					
A/D Inputs			5-Bit × 4ch (Conversion by Software)				
PWM			7-Bit × 6ch (Repetition Cycle 256 μs, at 6 MHz), 14-Bit × 1ch (Repetition Cycle 32 8 ms, at 6 MHz)				
Special Ports			Tri-State Output (PTO), Remote Control Reception				
CRTC			5 × 7 dots, 16 characters, 2 lines, 7 colors, 56 patterns, Rounding function, Framing function				
Notes			Remote Control Data Detection Circuit built-in, For Voltage Synthesizer				
Package			SDIP042-P-0600				

Electrical Characteristics

Supply Current

Parameter	Symbol	Condition	min	Limit typ	max	Unit
Operating Supply Current	IDD1	fosc = 6 MHz, VDD = 5 V Ta = 25 °C	L	5 0	10	mA
Supply Current at STOP	IDD3	fosc = 0 Hz, VDD = 5 V $Ta = 25 \text{ °C}$			20	μΑ

(VDD = 5.0 V, VSS = 0 V)

A/D, D/A Converter Characteristics

Parameti	,	Symbol		Conditi	98	SSAN	Limit typ max	Unn
A/D Conversion Ab	solute Error		VDD	0 = 5 V, V	SS = 0 V	1_9	±1	LSB
Analog Input Vol	tage					VSS	VDD	

(VDD = 5.0 V, VSS = 0 V, Ta = 25 °C, 80 °C)

Support Tool

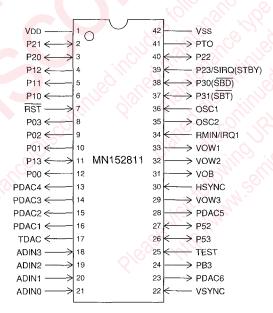
In-Circuit Emulator

PX-ICE1500 + PX-PRB152811

Piggyback

Use **EP152811**

Pin Assignment



SDIP042-P-0600

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